

# **Description**

The DMP4047SK3-13 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

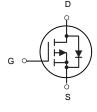
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#### TO-252-2L

#### **General Features**

 $V_{DS} = -40V I_{D} = -25A$ 

 $R_{DS(ON)}$  < 44 m $\Omega$  @  $V_{GS}$ =10V



#### P-Channel MOSFET

#### **Application**

Battery protection

Load switch

Uninterruptible power supply

## **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
DMP4047SK3-13	TO-252-2L	HXY MOSFET	2500

### Absolute Maximum Ratings (T<sub>c</sub>=25<sup>°</sup>Cunless otherwise noted)

Symbol	Parameter	Rating	Units	
VDS	Drain-Source Voltage	-40	V	
VGS	Gate-Source Voltage	±20	V	
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	Current, V <sub>GS</sub> @ 10V <sup>1</sup> -25		
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	/ <sup>1</sup> -12		
IDM	Pulsed Drain Current <sup>2</sup>	-40	А	
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation⁴	sipation <sup>4</sup> 8		
TSTG	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
ReJA	Thermal Resistance Junction-ambient <sup>1</sup>	62	°C/W	
R <sub>θ</sub> JC	Thermal Resistance Junction-Case <sup>1</sup>	18.8	°C/W	



# **Electrical Characteristics** ( T<sub>J</sub>=25 °C unless otherwise specified)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> = -250µA	-40	-	-	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -40V, V <sub>GS</sub> =0V	-	-	-1	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> = ±20V	-	-	±100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_{D}=-250\mu A$	-1.0	-1.6	-2.5	V
D	Static Drain-Source on-Resistance	V <sub>GS</sub> = -10V, I <sub>D</sub> = -8A	-	31	44	mΩ
R <sub>DS(on)</sub>		$V_{GS}$ = -4.5V, $I_{D}$ = -5A	-	44	60	
C <sub>iss</sub>	Input Capacitance	\\ - 20\\ \\ -0\\	-	1034	-	рF
Coss	Output Capacitance	$V_{DS} = -20V, V_{GS} = 0V,$	-	107	-	pF
Crss	Reverse Transfer Capacitance	f=1.0MHz	-	79.5	-	pF
Qg	Total Gate Charge	\/ - 20\/   - 54	-	20	-	nC
Q <sub>gs</sub>	Gate-Source Charge	$V_{DS}$ = -20V, $I_{D}$ = -5A, $V_{GS}$ = -10V	-	3.5	-	nC
Q <sub>gd</sub>	Gate-Drain("Miller") Charge	V <sub>GS</sub> 10V	-	4.2	-	nC
t <sub>d(on)</sub>	Turn-on Delay Time		-	8	-	ns
t <sub>r</sub>	Turn-on Rise Time	$V_{DD}$ = -20V, $I_{D}$ = -5A,	-	15	-	ns
t <sub>d(off)</sub>	Turn-off Delay Time	$V_{GS}$ = -10V, $R_{GEN}$ =2.5 $\Omega$	-	23	-	ns
t <sub>f</sub>	Turn-off Fall Time		-	9	-	ns
Is	Maximum Continuous Drain to Source Diode Forward Current		-	-	-23	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	-40	Α
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> =0V, I <sub>S</sub> = -10A	-	-0.8	-1.2	V
trr	Reverse Recovery Time	VGS =0V, IS=-5A,	-	29	-	ns
Qrr	Reverse Recovery Charge	di/dt=100A/µs	-	20	-	nC

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

<sup>2.</sup> EAS condition:  $T_J$ = 25°C,  $V_{DD}$ = -20V,  $V_G$ = -10V, L=0.5mH,  $R_G$ = 25 $\Omega$ ,  $I_{AS}$ = -10.5A

<sup>3.</sup> Pulse Test: Pulse Width≤300µs, Duty Cycle≤2%



# **Typical Performance Characteristics**

Figure1: Output Characteristics

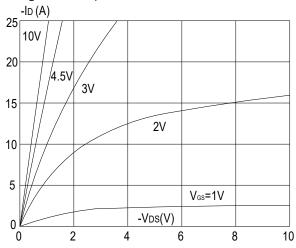


Figure 3:On-resistance vs. Drain Current

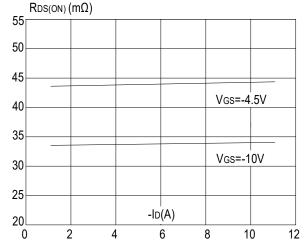


Figure 5: Gate Charge Characteristics

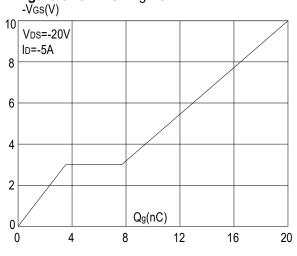


Figure 2: Typical Transfer Characteristics

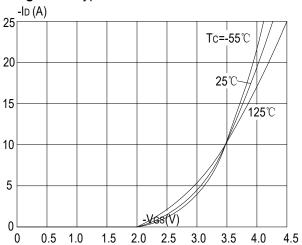


Figure 4: Body Diode Characteristics

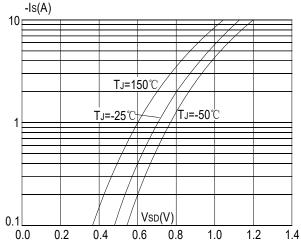
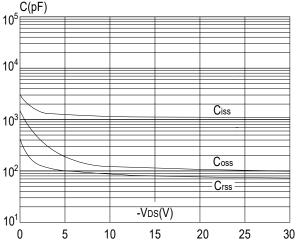


Figure 6: Capacitance Characteristics





**Figure 7:** Normalized Breakdown Voltage vs. Junction Temperature

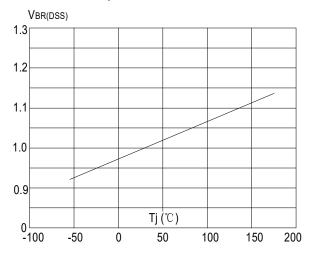
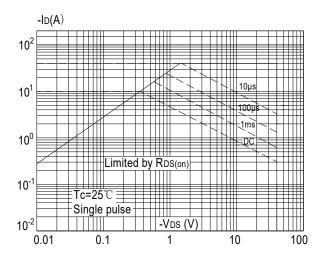
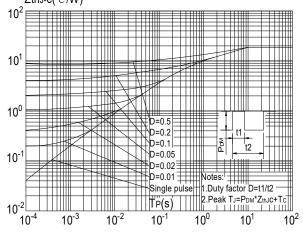


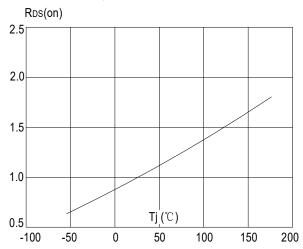
Figure 9: Maximum Safe Operating Area



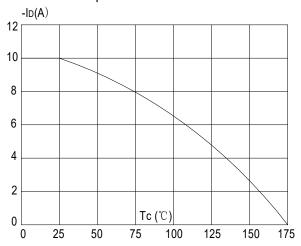
**Figure.11:** Maximum Effective Transient Thermal Impedance, Junction-to-Case  $ZthJ-c(^{\circ}C/W)$ 



**Figure 8:** Normalized on Resistance vs. Junction Temperature



**Figure 10:** Maximum Continuous Drain Current vs. Case Temperature



## **Test Circuit**

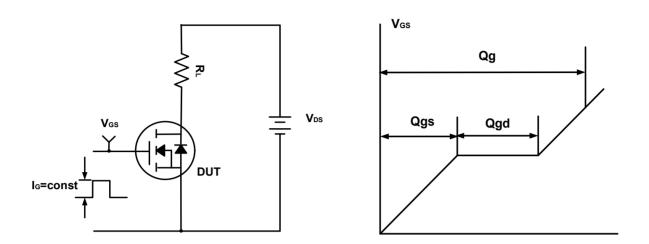


Figure A. Gate Charge Test Circuit & Waveforms

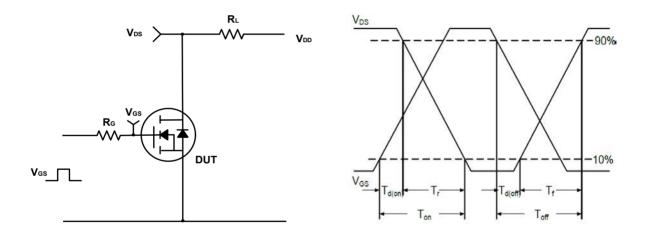


Figure B. Switching Test Circuit & Waveforms

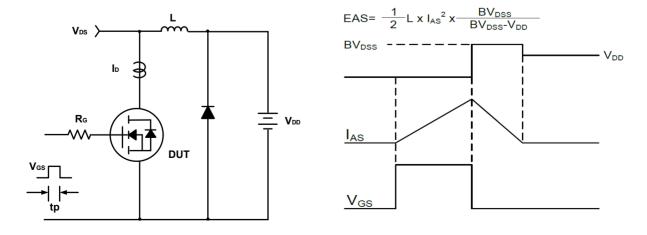
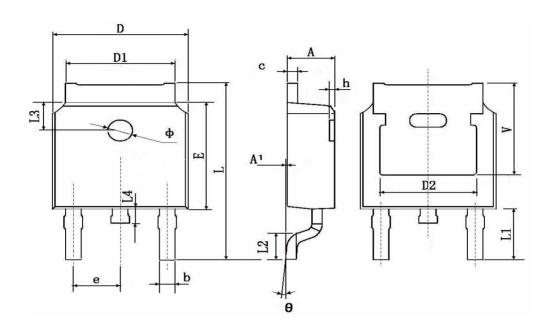


Figure C. Unclamped Inductive Switching Circuit & Waveforms

# **TO-252-2L Package Information**



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min.	Max.	Min.	Max.	
А	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830 TYP.		0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900 TYP.		0.114 TYP.		
L2	1.400	1.700	0.055	0.067	
L3	1.600	1.600 TYP.		0.063 TYP.	
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		



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